

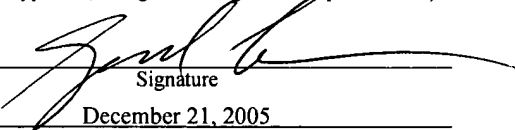
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : YAZAWA, Kazuaki
Appl. No. : 10/681,073
Filed : October 8, 2003
Title : HEAT DISSIPATING STRUCTURE FOR AN ELECTRONIC DEVICE
Art Unit : 2835
Examiner : DATSKOVSKIY, Michael V.

745 Fifth Avenue
New York, NY 10151

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Samuel S. Lee, Reg. No. 42,791
(Name of Applicant, Assignee or Registered Representative)


Signature
December 21, 2005
Date of Signature

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of September 13, 2005, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims, which begins on page 3.

Remarks/Arguments begin on page 7.